

□ MN101C78 Series

Type	MN101C78A	MN101CF78A
Internal ROM type	Mask ROM	FLASH
ROM (byte)	32K	
RAM (byte)	1.5K	
Package (Lead-free)	TQFP048-P-0707B	
Minimum Instruction Execution Time	0.100 μ s (at 3.0 V to 3.6 V, 10 MHz) 0.118 μ s (at 2.7 V to 3.6 V, 8.5 MHz) 0.235 μ s (at 1.8 V to 3.6 V, 4.25 MHz)* 62.5 μ s (at 1.8 V to 3.6 V, 32 kHz)* *: The lower limit for operation guarantee for flash memory built-in type is 2.2 V.	

■ Interrupts

RESET. Watchdog. External 0 to 2. External 4 (key interrupt dedicated). Timer 0 to 3. Timer 6. Timer 7 (2 systems). Timer 8 (2 systems). Time base. Serial 0 (2 systems). Serial 1 (2 systems). Serial 3. Serial 4. A/D conversion finish

■ Timer Counter

8-bit timer \times 5

- Timer 0Square-wave/8-bit PWM output. Event count. Remote control carrier output. Simple pulse width measurement. Added pulse (2-bit) type PWM output. Real time output control. Square-wave/PWM output to large current terminal P50 possible
- Timer 1Square-wave output. Event count. Synchronous output event
- Timer 2Square-wave output. Added pulse (2-bit) type PWM output. PWM output. Serial transfer clock output. Real time output control. Event count. Synchronous output event. Simple pulse width measurement. Square-wave/PWM output to large current terminal P52 possible
- Timer 3Square-wave output. Event count. Remote control carrier output. Serial 0 baud rate timer
- Timer 68-bit freerun timer
- Timer 0, 1 can be cascade-connected
- Timer 2, 3 can be cascade-connected

16-bit timer \times 2

- Timer 7Square-wave output. 16-bit PWM output (cycle/duty continuous variable). Event count. Synchronous output event. Pulse width measurement. Input capture. Real time output control. High performance IGBT output. Square-wave/PWM output to large current terminal P51 possible
- Timer 8Square-wave/16-bit PWM output (duty continuous variable). Event count. Pulse width measurement. Input capture. Square-wave/PWM output to large current terminal P53 possible
- Timer 7, 8 can be cascade-connected: Square-wave output, PWM, input capture, pulse width measurement is possible as a 32-bit timer

Time base timer: One-minute count setting

Watchdog timer \times 1

■ Serial interface

Synchronous type/UART (full-duplex) \times 2: Serial 0, 1

Synchronous type/Single-master I²C \times 1: Serial 3

I²C slave \times 1: Serial 4

Serial 4.....I²C high-speed transfer mode. 7-bit/10-bit address setting. General call

■ I/O Pins

I/O 39 : Common use. Specified pull-up resistor available. Input/output selectable (bit unit)

■ A/D converter

10-bit \times 7 channels (with S/H)

■ Display control function

LCD: 12 segments \times 4 commons (Static, 1/2, 1/3, or 1/4 duty)

Usable if VLCD \leq VDD

■ Special Ports

Buzzer output. Inverted buzzer output. Remote control carrier output. High-current drive port

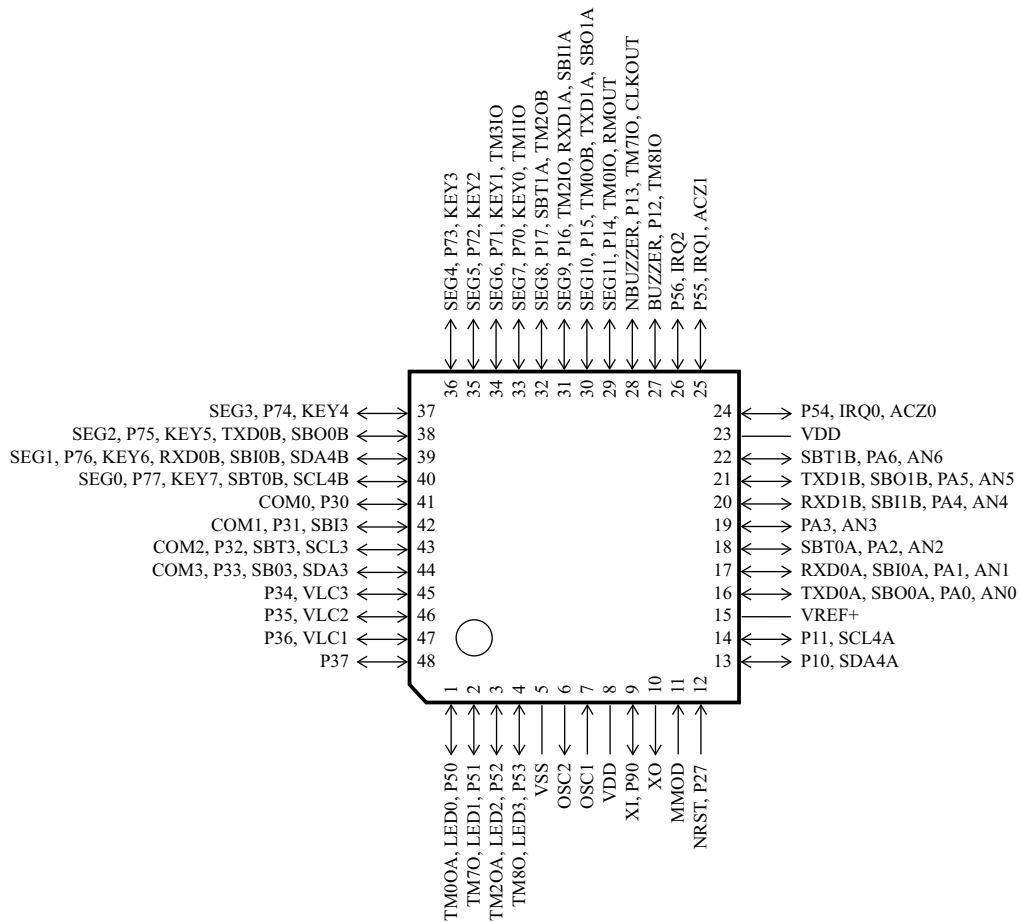
■ Electrical Characteristics (Supply current)

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Operating supply current	IDD1	fosc = 4.25 MHz (fs = fosc/2). VDD = 3 V		0.6(1.3)	1.1(2.2)	mA
	IDD2	fx = 32 kHz (fs = fx/2). VDD = 3 V		4(46)	15(90)	μA
Supply current at HALT	IDD3	fx = 32 kHz. VDD = 3 V. Ta = 25 °C		2(3)	5(13)	μA
	IDD4	fx = 32 kHz. VDD = 3 V. Ta = -40 °C to +85 °C			10(40)	μA
Supply current at STOP	IDD5	VDD = 3 V. Ta = 25 °C			2(3)	μA
	IDD6	VDD = 3 V. Ta = -40 °C to +85 °C			8(30)	μA

Note) (): Flash memory built-in type

■ Pin Assignment

TQFP048-P-0707B



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